■ SPECIFICATIONS

ltem -			Standard Type	Single Winding Latching Type	Double Winding Latching Type			
			UM1-() W-K	UM1L-() W-K	UM1L-D()W-K			
Contact	Arrangement		1 form C (SPDT)					
	Material		Gold clad (stationary contact), gold plate (movable contact)					
	Style		Bifurcated (cross bar)					
	Resistance (initial)		Maximum 100 m Ω					
	Rati (resistive)		10 mA 24 VDC 1 W (at 900 MHz)					
	/ <u>/im</u> /	arrying Current	0.5 A					
	Maxin n S	witching Power	1 W (DC) 10 W (at 900 I	1 W (DC) 10 W (at 900 MHz)				
)	אי או Sי	Voltage	30 VDC					
	Maximum witching ant		100 mA					
	Minimum vitchi Load*		0.01 mA 10 mVDC					
Excellent High	Isolation		iinimum 60 dB (at 900 MHz), impedance of the measuring devices is 75 Ω					
Frequency Character-	Insertion Loss		May Jum 1 dB (at 900 MHz), impedance of the measuring devices is 75Ω					
istics	V.S.W.R.		aximur 1 2 (at 900 MHz), impedance of the measuring devices is 75 Ω					
Coil	Nominal Power (at 20°C)		200 t _20 mV'	200 mW	400 mW			
	Operate Power (at 20°C)		10 .0 110 / /	100 mW	200 mW			
	Operating Temperature		-30°C tr 30°C ir ros	-30°C to +60°C (no frost)				
Time Value	Operate (at nominal voltage)		Maximum 6 s M mum 6 ms (set)					
	Release (at nominal voltage)		Maximum 5 ms (reset)					
Life	Mechanical		1 × 10 ⁶ operations mi num					
	Electrical		3 × 10 ⁵ operations minim (atinal load)					
Other	Vibration	Misoperation	10 to 55 Hz (double amp					
	Resistance	Endurance	10 to 55 Hz (double amplitude of 0.0 r .)					
	Shock	Misoperation	500 m/s ² (11 ±1 ms)					
	Resistance Endurance		1,000 m/s ² (6 ±1 ms)					
	Weight		Approximately 4 g					

^{*1} Minimum switching loads mentioned above are reference values. Please perform the confirmation to struct the actual load before production since reference values may vary according to switching frequencies, environmentary of the confirmation to struct the actual load before production since reference values may vary according to switching frequencies, environmentary of the confirmation to structure.

■ INSULATION

Item	Standard	Single latch	Double latch		
Isolation (initial)	Minimum 1,000 MΩ (at 500VDC)				
Dielectric Strength	500VAC 1 min., (open contact / contact and shield terminals)				
	1,000VAC 1 min., (coil contact/ coil and shield terminals)				

■ COIL DATA CHART

MODEL		Nominal voltage	Coil resistance (±10%)	Must operate voltage*1	Must release voltage*1	Nominal power
Standar Type	UM1- 1.5 W-K	1.5 VDC	11.2Ω	+1.05 VDC	+0.08 VDC	200 mW
	UM1- 3 W-K	3 VDC	45 Ω	+2.1 VDC	+0.15 VDC	200 mW
	UN' 15 W-K	4.5 VDC	101 Ω	+3.15 VDC	+0.23 VDC	200 mW
	л1- W-K	5 VDC	125 Ω	+3.5 VDC	+0.25 VDC	200 mW
	UM ¹ 6 V .	6 VDC	180 Ω	+4.2 VDC	+0.3 VDC	200 mW
	Uıvı1- ,√-K	9 VDC	405 Ω	+6.3 VDC	+0.45 VDC	200 mW
	UM1- 12 W-K	12 VDC	720 Ω	+8.4 VDC	+0.6 VDC	200 mW
	UM1- 18 '-K	1 VDC	1,620 Ω	+12.6 VDC	+0.9 VDC	200 mW
	UM1- 24 W-K	2 2	2,880 Ω	+16.8 VDC	+1.2 VDC	200 mW
	UM1- 48 W-K	48 VD′	10,472 Ω	+33.6 VDC	+2.4 VDC	220 mW

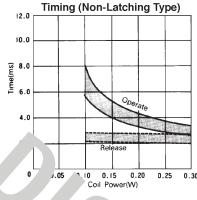
Note: *1 Specified values are subject to risk way voltage.
All values in the table are measured at 50°C

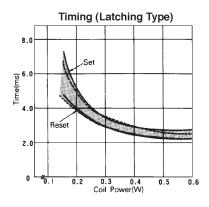
MODEL		Nominal voltage	Coil resistance (±10%)	Set voltage* ¹	Reset voltage* ¹	Nominal power
Single Winding Latching Type	UM1L- 1.5 W-K	1.5 VDC	11.2Ω	+1.05 VDC	-1.05 VDC	200 mW
	UM1L- 3 W-K	3 VDC	45 Ω	+2.1 VDC	-2.1 VDC	200 mW
	UM1L- 4.5 W-K	4.5 VDC	101 Ω	+3.15 VDC	-3.15 VDC	200 mW
	UM1L 5 W-K	5 VDC	125 Ω	+3.5 VDC	-3.5 VDC	200 mW
	UM' - 3 W-K	6 VDC	180 Ω	+4.2 VDC	-4.2 VDC	200 mW
ding	/الـ / W-۲	9 VDC	405 Ω	+6.3 VDC	-6.3 VDC	200 mW
Win	12 K	12 VDC	720 Ω	+8.4 VDC	-8.4 VDC	200 mW
) gle	UM1L- , W-K	18 VDC	1,620 Ω	+12.6 VDC	-12.6 VDC	200 mW
Sin	UM1L- 24 W-K	VDC	2,880 Ω	+16.8 VDC	-16.8 VDC	200 mW
	UM1L- 48 W-1	48 VDC	11,520 Ω	+33.6 VDC	-33.6 VDC	200 mW
	UM1L-D1.5 W-K	1 ,DC	Ρ 5.6Ω	+1.05 VDC		400 mW
			S 5.6Ω		+1.05 VDC	
	UM1L-D 3 W-K	CC	Ρ 22.5Ω	+2.1 VDC		400 mW
			<u>Σ</u> . 5Ω		+2.1 VDC	
	UM1L-D4.5 W-K	4.5 VDC	P J.652	+3.15 VDC		400 mW
			5 50.60		+3.15 VDC	
lype	UM1L-D 5 W-K	5 VDC	P 6' 1	+3.5 VDC		400 mW
Double Winding Latching Type			S 62.59		+3.5 VDC	
atch	UM1L-D 6 W-K	6 VDC	Ρ 90 Ω	+4 VDC		400 mW
lg L			S 90 Ω		+4.2 VDC	
ndir	UM1L-D 9 W-K	9 VDC	Ρ 202.5Ω	ar VDr		400 mW
l S			S 202.5Ω		, VDC	
gn	UM1L-D 12 W-K	12 VDC	Ρ 360 Ω	+8.4 VD		400 mW
			S 360 Ω		, VDC	
	UM1L-D 18 W-K	18 VDC	Ρ 810 Ω	+12.6 VDC		400 mW
			S 810 Ω		+12.6 /DC	
	UM1L-D 24 W-K	24 VDC	Ρ1,440 Ω	+16.8 VDC		400 mW
			S 1,440 Ω		+16.8 VDC	
	UM1L-D 48 W-K	48 VDC	Ρ 5,760 Ω	+33.6 VDC		△ 00 r iW
			S 5,760 Ω		+33.6 VDC	

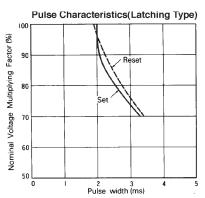
Note: *1 Specified values are subject to pulse wave voltage. All values in the table are measured at 20°C .

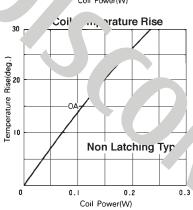
P: Primary coil S: Secondary coil

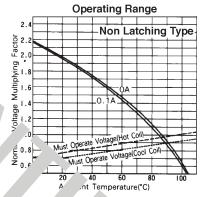
■ CHARACTERISTIC DATA



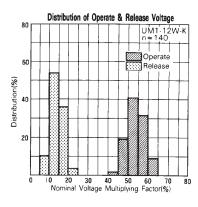


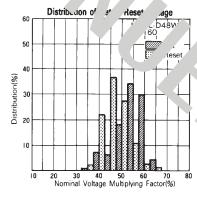


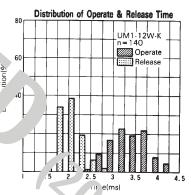


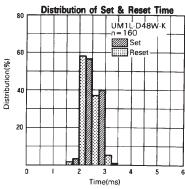


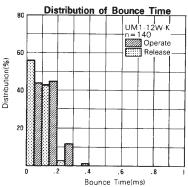
■ REFERENCE DATA

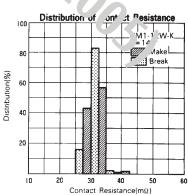


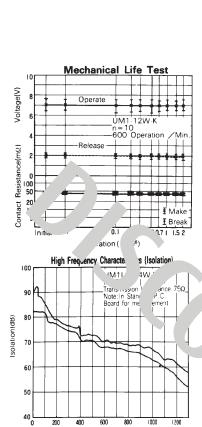


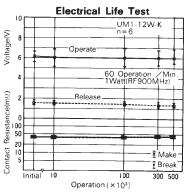


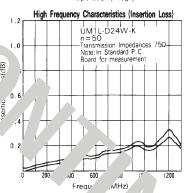


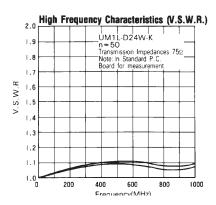












■ DIMENSIONS

0.4

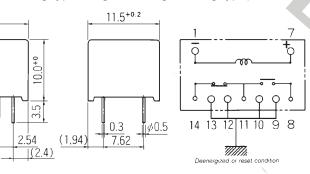
Dimensions

20.1+0.2

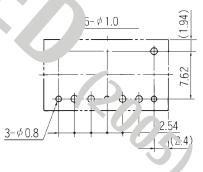
Frequency(MHz)

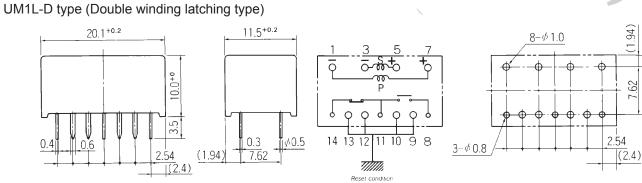
Schame (Bottom view)

UM1, UM1L type (Non-latching type, single winding latching type)



PC board mounting hole layout (Bottom view)





Unit: mm

RoHS Compliance and Lead Free Relay Information

1. General Information

- Relays produced after the specific date code that is indicated on each data sheet are lead-free now. All our signal and power relays are lead-free. Please refer to Lead-Free Status Info. (http://www.fujitsu.com/us/downloads/MICRO/fcai/relays/lead-free-letter.pdf)
- Lead free solder plating currently used in relays is Sn-3.0Ag-0.5Cu. From February 2005 forward Sn-2 Cu- will be used for FTRB3 and FTR-B4 series relays.
- A' .gnal .d p ver relays also comply with RoHS. Please refer to individual data shouth are RoHS compliant do not contain the 6 hazardous materials above the threshold level that are recorded by holds directive (lead, mercury, cadmium, chromium IV, PBB, PBDE and DecaBDE).
- It has been verific that using lead-free relays in leaded assembly process will not cause any problems (comparable)
- "LF" is marked on each outer and inner carton. (No marking on individual relays).

2. Recommended L ad r er older Profile

• Recommended solder paste Sn-3 ' \(\text{xg} \) .5 (\(\text{...} \).

Solder condition

Flow Solder condition:

Pre-heating: maximum 120°C dip within 5 sec. at 260°C solder bath

Solder by Soldering Iron:

Soldering Iron

Temperature: maximum 360°C Duration: maximum 3 sec.

We highly recommend that you confirm your actual solder conditions

3. Moisture Sensitivity

Moisture Sensitivity Level standard is not applicable to electromechanical relays.

4. Tin Whisker

 Dipped SnAgCu solder is known as low risk tin whisker. No considerable whisker length was found by our in house test.

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